

Australia-MMRC Party Ltd

Products - (All) Wafer Bonding, Dicing Systems, Dry Process Dicing

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MMRC Party Ltd

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China-Kestronics

Products - (All) Wafer Bonding, Dicing Systems, Dry Process Dicing

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Tel: +86 (21) 68755146

China-Luva Systems

Products - Wafer Bonding, Dicing Systems

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US Office

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European Union

Austria, Belgium, Denmark, Germany, Liechtenstein, Luxembourg, Netherlands, Switzerland, UK-Quality Control

Products – Wafer Bonding, Dicing Systems, Dry Process Dicing - Consumables only.

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QC-Quality Control GmbH

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Tel.: +49 (0) 8131 998099
www.qc-quality-control.de

France, Italy, Malta, Morocco , Portugal, Spain - STI

Products - (All) Wafer Bonding, Dicing Systems, Dry Process Dicing
Contact - Eric Lama
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STI - Systems and Technology International

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Tel: +331- 4595 - 4455
Fax: +331- 4595 - 4466
www.stifrance.com

Israel-Getter Bio Med

Products - (All) Wafer Bonding, Dicing Systems, Dry Process Dicing
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Getter Bio Med

Nano & Semiconductor Technologies
Life and Material Science Division
Tel: +03-5761620
www.getter.co.il/biomed

Japan-Tomoe Engineering Co, LTD

Products - Wafer Bonding, Dicing Systems
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Tomoe Engineering Co, Ltd

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www.tomo-e.com.jp

Malaysia-Kestronics

Products - (All) Wafer Bonding, Dicing Systems, Dry Process Dicing
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Philippines-Kestronics

Products - Dry Dicing Systems
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Philippines-RNM Dynamics Phils

Products - Wafer Bonding, Dicing Systems
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RNM Dynamics Phils, Inc.

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Singapore-Kestronics

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Thailand-Kestronics

Products -(All) Wafer Bonding, Dicing Systems, Dry Process Dicing

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